

MOS FIELD EFFECT TRANSISTOR

2SK3304

SWITCHING

N-CHANNEL POWER MOS FET

INDUSTRIAL USE

DESCRIPTION

The 2SK3304 is N-Channel MOS FET device that features a Low gate charge and excellent switching characteristics, and designed for high voltage applications such as switching power supply.

FEATURES

- Low gate charge :
 $Q_G = 44 \text{ nC TYP. (} V_{DD} = 450 \text{ V, } V_{GS} = 10 \text{ V, } I_D = 7.0 \text{ A)}$
- Gate voltage rating : $\pm 30 \text{ V}$
- Low on-state resistance :
 $R_{DS(on)} = 2.0 \Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 4.0 \text{ A)}$
- Avalanche capability ratings

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Drain to Source Voltage	V_{DSS}	900	V
Gate to Source Voltage	$V_{GSS(AC)}$	± 30	V
Drain Current (DC)	$I_{D(DC)}$	± 7	A
Drain Current (Pulse) ^{Note1}	$I_{D(pulse)}$	± 21	A
Total Power Dissipation ($T_C = 25^\circ\text{C}$)	P_T	130	W
Total Power Dissipation ($T_A = 25^\circ\text{C}$)	P_T	3.0	W
Storage Temperature	T_{stg}	-55 to + 150	$^\circ\text{C}$
Single Avalanche Current ^{Note2}	I_{AS}	7	A
Single Avalanche Energy ^{Note2}	E_{AS}	147	mJ

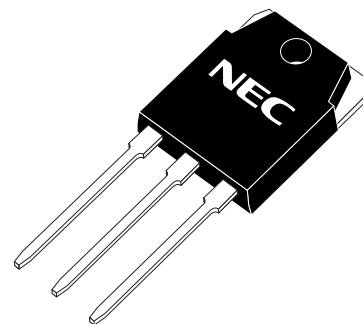
Notes 1. $PW \leq 10 \mu\text{s}$, Duty cycle $\leq 1 \%$

2. Starting $T_{ch} = 25^\circ\text{C}$, $V_{DD} = 150 \text{ V}$, $R_G = 25 \Omega$, $V_{GS} = 20 \text{ V} \rightarrow 0 \text{ V}$

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3304	TO-3P

(TO-3P)



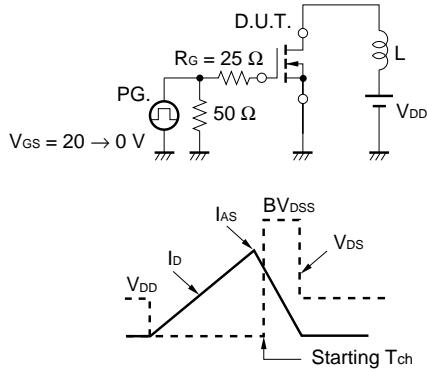
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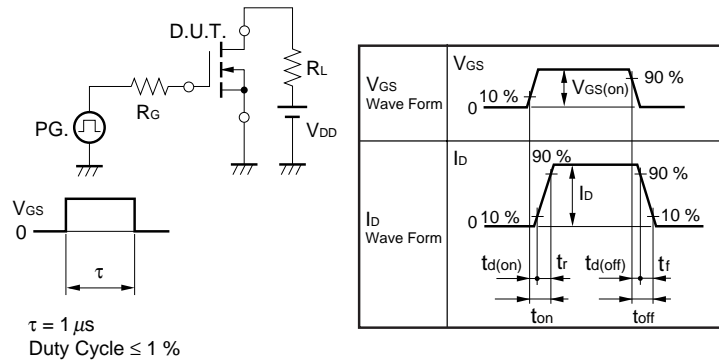
ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Leakage Current	I _{DSS}	V _{DS} = 900 V, V _{GS} = 0 V			100	μA
Gate to Source Leakage Current	I _{GSS}	V _{GS} = ±30 V, V _{DS} = 0 V			±100	nA
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1.0 mA	2.5		3.5	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 20 V, I _D = 4.0 A	2.5	4.7		S
Drain to Source On-state Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 4.0 A		1.6	2.0	Ω
Input Capacitance	C _{iss}	V _{DS} = 10 V		1300		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V		240		pF
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		55		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 150 V		20		ns
Rise Time	t _r	I _D = 4.0 A		44		ns
Turn-off Delay Time	t _{d(off)}	V _{GS(on)} = 10 V		73		ns
Fall Time	t _f	R _G = 10 Ω, R _L ≅ 36 Ω		45		ns
Total Gate Charge	Q _G	V _{DD} = 450 V		44		nC
Gate to Source Charge	Q _{GS}	V _{GS} = 10 V		6		nC
Gate to Drain Charge	Q _{GD}	I _D = 7.0 A		28		nC
Body Diode Forward Voltage	V _{F(S-D)}	I _F = 7.0 A, V _{GS} = 0 V		1.0		V
Reverse Recovery Time	t _{rr}	I _F = 7.0 A, V _{GS} = 0 V		2.4		μs
Reverse Recovery Charge	Q _{rr}	di/dt = 50 A/μs		13.5		μC

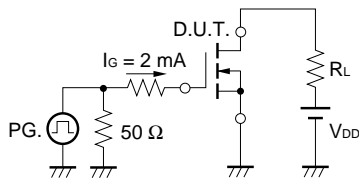
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME

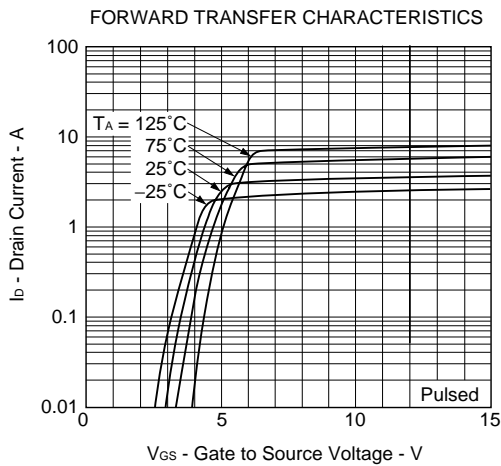
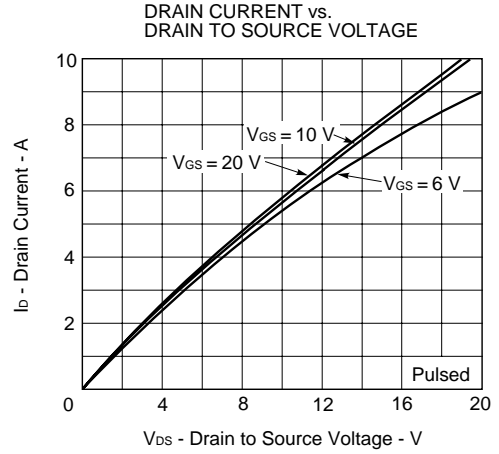
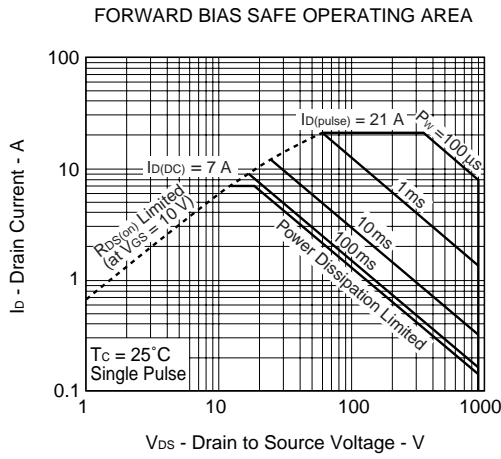
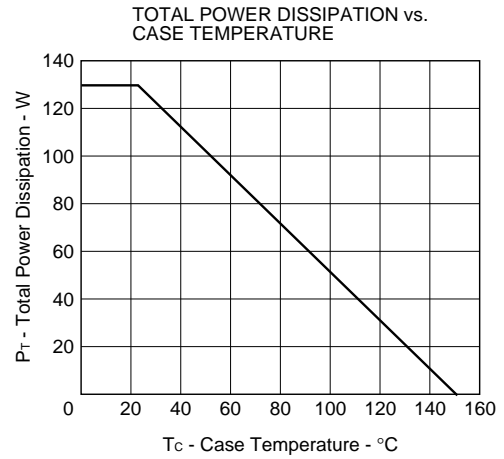
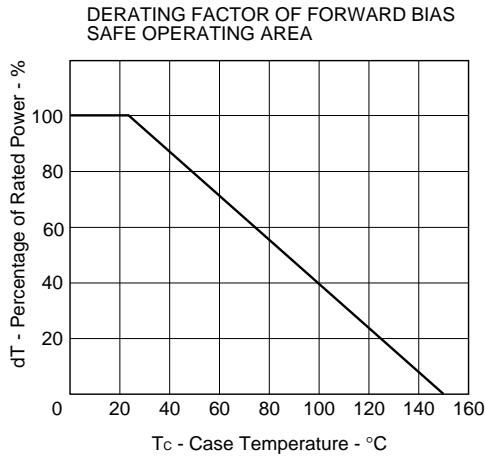


TEST CIRCUIT 3 GATE CHARGE



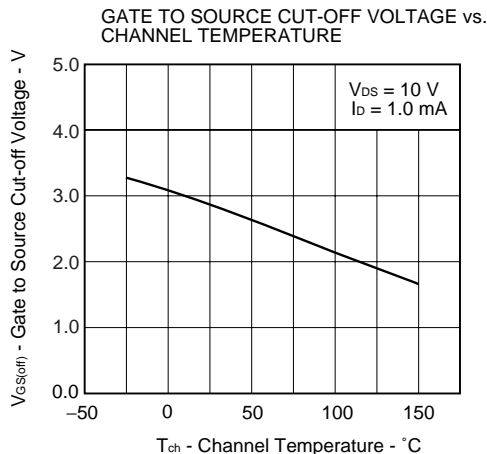
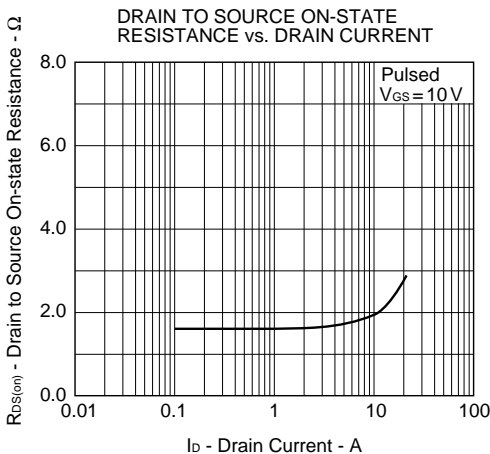
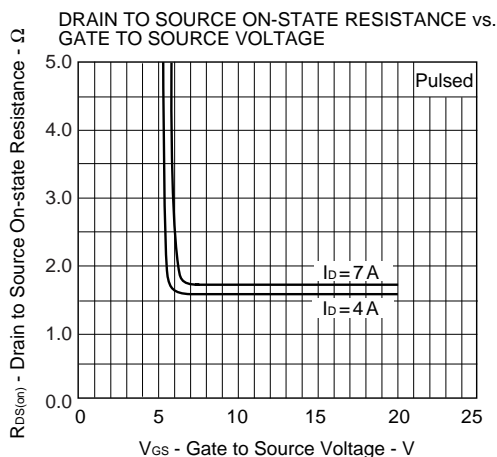
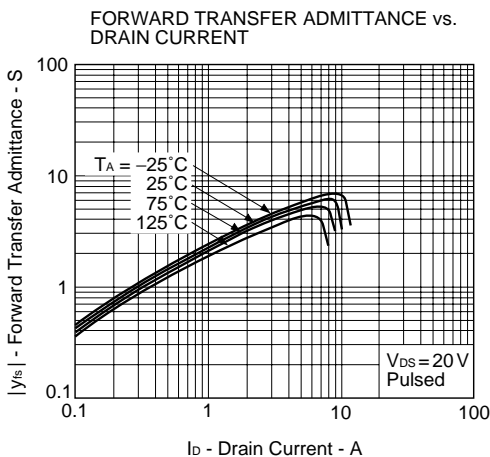
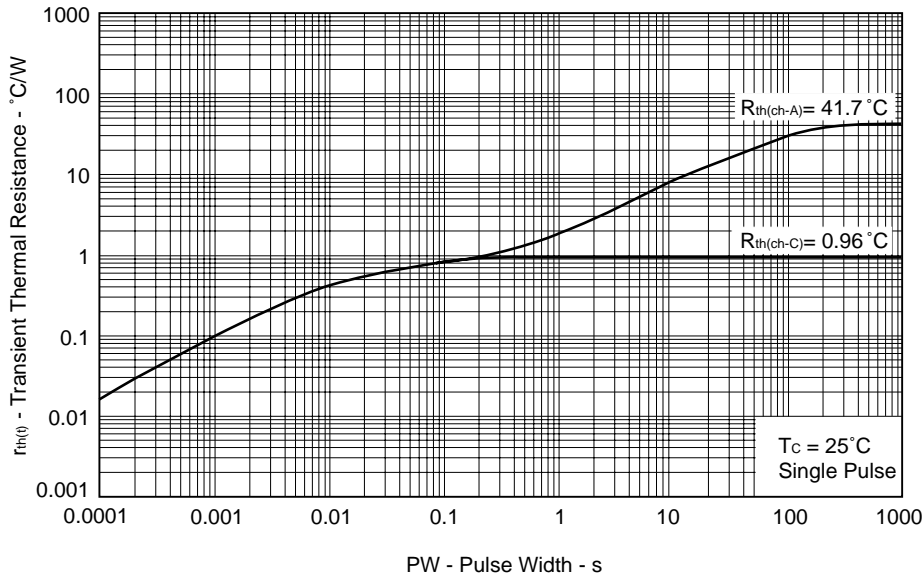
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TYPICAL CHARACTERISTICS (T_A = 25 °C)

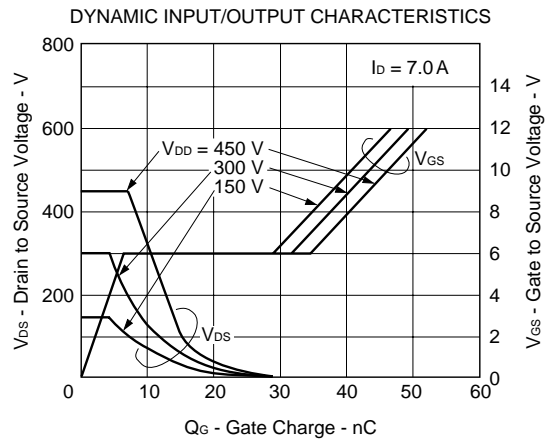
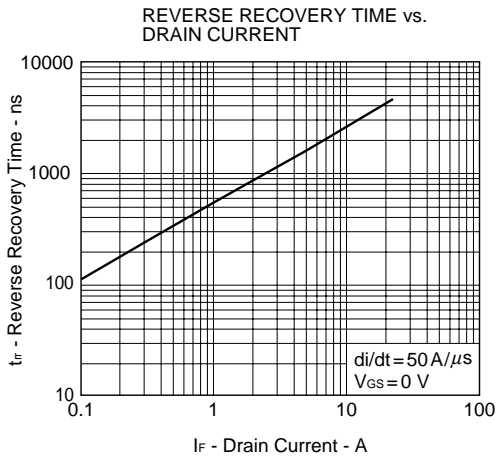
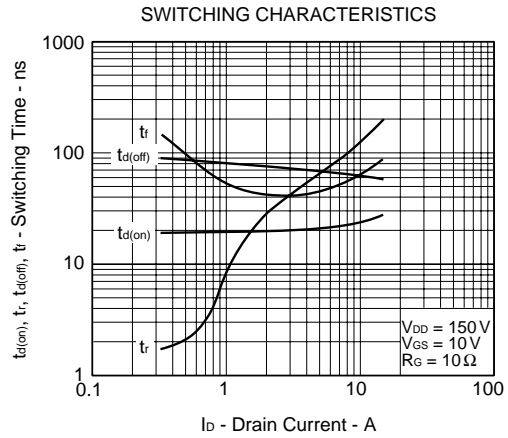
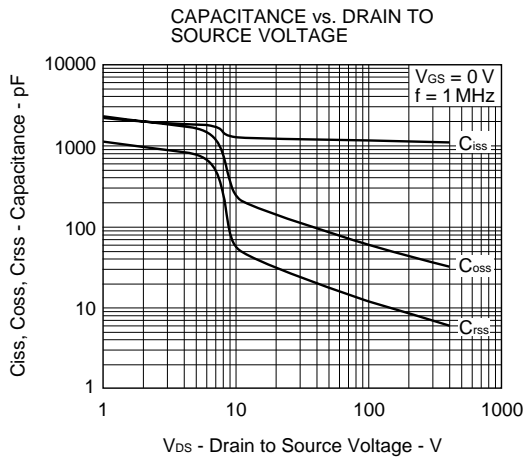
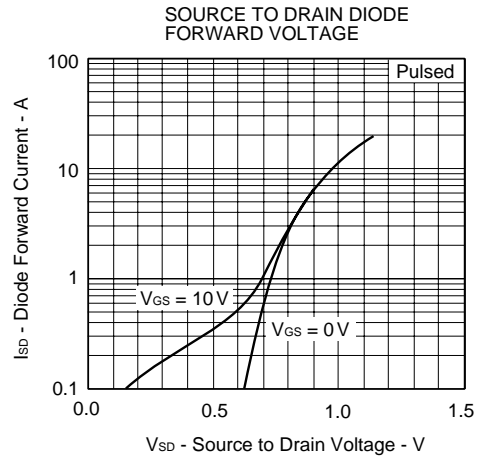
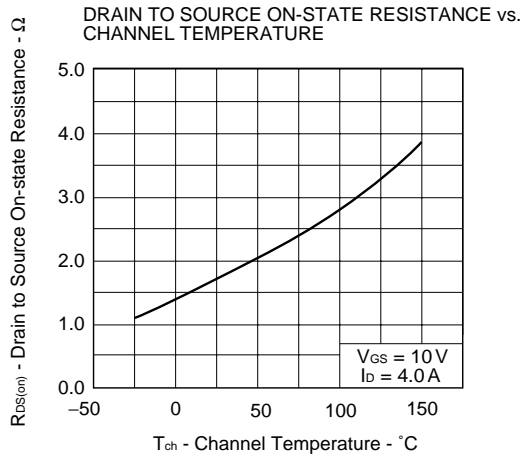


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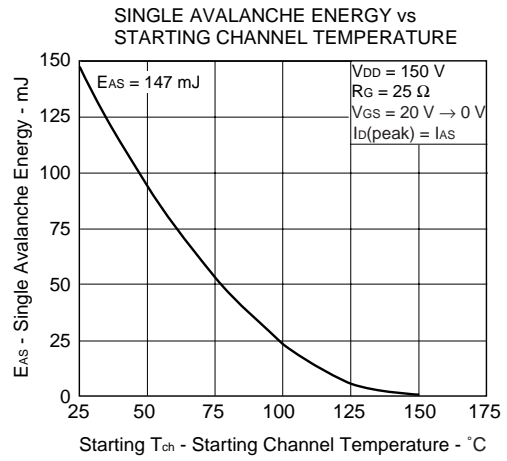
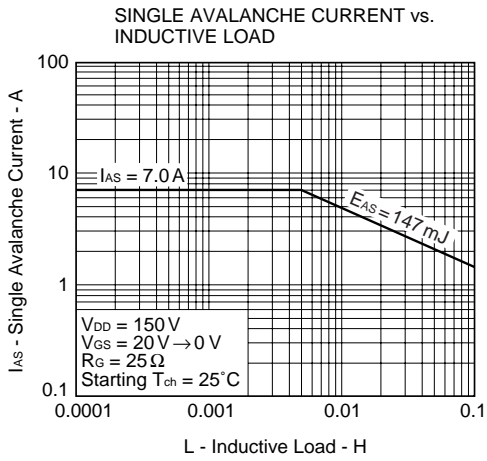
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



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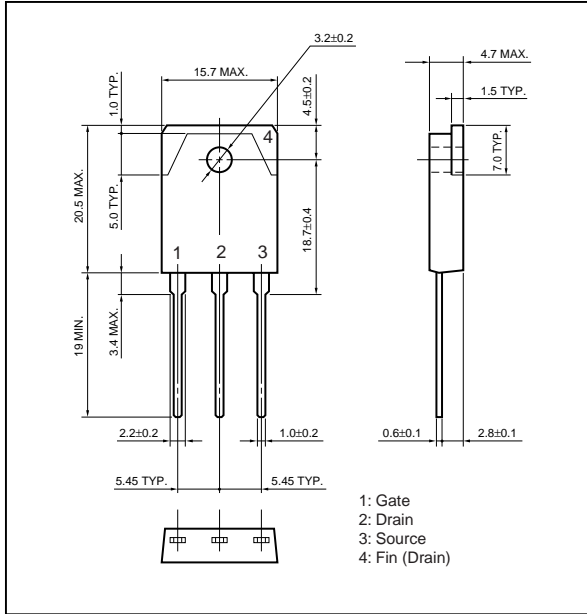


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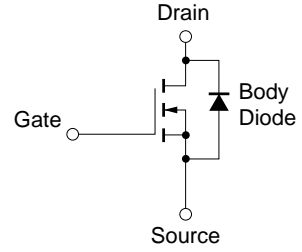


PACKAGED DRAWING (Unit : mm)

TO-3P (MP-88)



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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